

Preparation of nano-sized TiN coated α -Si₃N₄ particles

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α -Si₃N₄ particles coated with 10 and 25 vol% nano-sized TiN were prepared by coating the surface of the Si₃N₄ particles with TiO₂, followed by nitridation. Coating by TiO₂ was accomplished by dispersing α -Si₃N₄ powders (0.16 and 1.6 g l⁻¹) in a solution of TiCl₄, urea and aqueous HCl, and heating at 105 °C for 130 and 190 min. The success of the coating procedure was confirmed by TEM observation with electron diffraction and EDX analysis. Zeta potential measurements suggest that the TiO₂ coating on the surface of Si₃N₄ particles occurs at a pH between 3.7 and 4.3 by the attractive force of opposite charges. When the TiO₂ on the surface of the Si₃N₄ is nitrided with NH₃ gas at 1000 °C, it is completely changed to TiN of uniform particle size (20 nm).

Introduction

Si₃N₄ ceramics are promising high temperature structural materials^{1,2} but are difficult to mechanically form into complex shapes because of their toughness and hardness. Si₃N₄-matrix ceramics containing highly electrically conductive TiN^{2,3} can be machined to desired shapes by electric discharge machining. These Si₃N₄-matrix ceramics containing TiN were fabricated by sintering mechanically mixed Si₃N₄ or Si and TiN or TiO₂ powders,⁴⁻⁷ but the mixtures contained an inhomogeneous distribution of TiN, necessitating an increased amount of TiN. It is known that coating dispersed particles with other materials constitutes a method for homogeneous mixing, leading to several reports dealing with the coating of Si₃N₄ by sintering oxide additives such as Al₂O₃, Y₂O₃, La₂O₃ or MgO,⁸⁻¹⁰ to reduce the amount of oxide needed to promote full densification. If Si₃N₄ could be coated by fine TiO₂ particles in a controlled manner, the composite powders would be densified at TiN contact without sintering additives, since monolithic nano-sized TiN is sintered by field-assisted sintering.¹¹ Thus, Si₃N₄-matrix ceramics with continuous TiN networks, which exhibit high electrical conductivities, should be obtained from the tailored composite powders. However, the preparation of TiN coated Si₃N₄ particles has been reported only by Narula and coworkers¹² whose TiN coated Si₃N₄ composite particles were obtained by direct deposition of TiN through the pyrolysis of (CH₃)₃SiNHTiCl₃ with Si₃N₄ at 600 °C. According to this report, the yield of the precursor of (CH₃)₃SiNHTiCl₃ was low and the composite particles contained Si, Cl and C impurities. It would be interesting to fabricate TiN coated Si₃N₄ composite particles from TiO₂-coated Si₃N₄ by subsequent nitridation of the TiO₂, to obtain samples of good purity and controlled TiN particle size. Although alkoxides such as Ti(OC₂H₅)₄ and Ti(OC₃H₇)₄ are well known starting materials for the formation of TiO₂,¹³⁻¹⁷ they are expensive and sensitive to atmospheric moisture. An additional disadvantage is the retention of carbon impurities in the TiO₂ product. The preparation of TiO₂ particles through the thermal hydrolysis of TiCl₄ by urea¹⁸ has the advantage that TiCl₄ is cheap and easily handled in air.

In coating the matrix Si₃N₄ particles with a second phase (TiO₂) from solution, it is important to know the zeta potential^{8,9,19-21} of both particles, since the success of the

coating depends on the surface charge of the two particles. Changes in the zeta potential of the particles with pH should indicate the pH at which the coating by TiO₂ of Si₃N₄ should occur.

The purpose of this study was to prepare nano-sized TiN coated α -Si₃N₄ particles by depositing TiO₂ on the surface of Si₃N₄ particles by thermal hydrolysis of TiCl₄ with urea, followed by nitridation of the TiO₂ by NH₃ gas. The coating process is discussed on the basis of zeta potential measurements for Si₃N₄ and TiO₂ and TEM observation of the coated particles.

Experimental procedure

Preparation of TiO₂ coated α -Si₃N₄ composite particles

A flow chart of the experimental procedure for preparing TiN coated Si₃N₄ particles is shown in Fig. 1. The starting materials were Si₃N₄ ($\alpha > 95\%$) with a mean particle size of 0.5 μ m (UBE Industries, Tokyo, Japan), TiCl₄ (KANTO Chemical, Co., Inc., Tokyo, Japan) and urea (KANTO Chemical, Co., Inc., Tokyo, Japan). The Si₃N₄ powder was added to a solution of HCl, TiCl₄ and urea (79.9 g), and ultrasonically dispersed for 15 min. The amount of TiCl₄ with respect to Si₃N₄ was adjusted to 10 and 25 vol% of the reduced volume of TiN in Si₃N₄. For example, the amount of TiCl₄ needed for 25 vol% TiN is 0.025 and 0.25 ml at Si₃N₄ contents of 0.16 and 1.6 g l⁻¹, respectively. The suspension was heated at 105 °C for 130 or 190 min in flowing N₂ gas. For comparison, TiCl₄ was slowly dropped into a dispersion of Si₃N₄ in aqueous NH₃ solution (28 vol.%) (KANTO Chemical, Co., Inc., Tokyo, Japan), omitting the urea and without heating. The TiO₂-coated Si₃N₄ particles from both methods were washed several times with distilled water and dried at 60 °C. The dried particles were observed by TEM and identified by XRD. The existence of TiO₂ on the Si₃N₄ surface was ascertained by electron diffraction and EDX analysis.

The zeta potentials of the Si₃N₄ powder and the TiO₂ precipitate prepared from TiCl₄ by thermal hydrolysis were measured using a Zeta plus apparatus (Brookhaven Instrument Corporation) in distilled water adjusted to a pH range of 3 to 7 with HCl solution. KCl solution (0.01 mol l⁻¹) was added to the solvent to keep the ion strength constant.

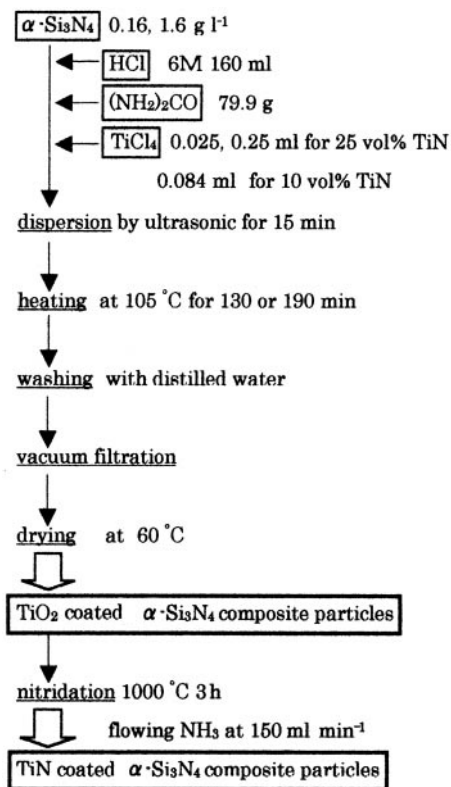


Fig. 1 Flow chart of the experimental procedure.

Nitridation

In the preliminary experiments, TiO₂ obtained by thermal hydrolysis of TiCl₄ for 190 min was nitrided in flowing NH₃ gas (150 ml min⁻¹) at 900 and 1000 °C for 180 min. Based on these results, the TiO₂ coated Si₃N₄ composite particles were nitrided at 1000 °C for 180 min. The TiN coated Si₃N₄ composite particles were identified by XRD and the lattice constant (*a*₀) of TiN was determined from the 311 diffraction peak. The size and shape of these particles were determined by TEM observation. The electrical resistivity of the compact composite powder containing 25 vol% TiN at a uniaxial pressure of 20 MPa was measured by the two-probe method.

Results and discussion

Preparation of TiO₂ coated α-Si₃N₄ composite particles

TiCl₄ in the HCl solution containing Si₃N₄ and urea was hydrolyzed by NH₃ generated by the decomposition of urea on heating at 105 °C, during which the pH value increased from 1 to 7. A time of about 130 min was needed for the formation of TiO₂ by this method. Fig. 2 shows TEM photographs of the TiO₂ coated Si₃N₄ particles obtained after thermal hydrolysis for 130 and 190 min of the TiCl₄ solution containing 0.16 and 1.6 g l⁻¹ Si₃N₄, equivalent to 25 vol% of TiN. It is seen that the large particles are covered with nano-particles irrespective of the concentration of TiCl₄ and Si₃N₄ or the hydrolysis time. Rings in the electron diffraction patterns of the fine particles in Fig. 2(c) (see arrow) indicate the formation of TiO₂ (anatase). EDX analysis showed that the larger particles were composed of Si and N containing a trace of Ti with the fine particles containing Ti and O (Fig. 3). XRD analysis also indicates the appearance of broad TiO₂ peaks due to anatase. The nanometer sized particles are thus shown to be TiO₂ and the larger particles are α-Si₃N₄, indicating the successful preparation of composite particles of Si₃N₄ with a fine coating of TiO₂. Few TiO₂ particles are detected by TEM observation, suggesting that most of the TiO₂ formed from TiCl₄ is coating

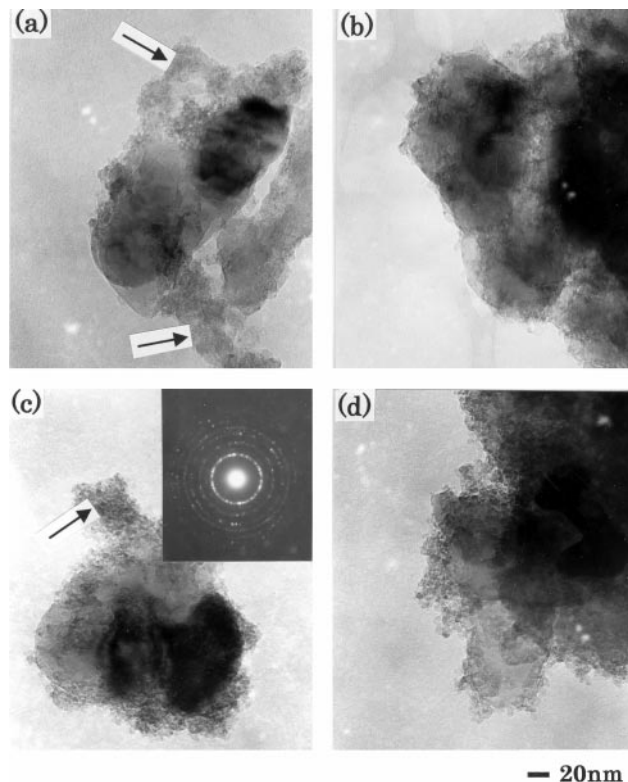


Fig. 2 TEM images of TiO₂ coated α-Si₃N₄ particles at 25 vol% TiN. Concentration/g l⁻¹ and hydrolysis time/min: (a) 0.16 and 130, (b) 0.16 and 190, (c) 1.6 and 130, (d) 1.6 and 190.

the Si₃N₄. With increasing hydrolysis time from 130 to 190 min, the size of the TiO₂ particles on the surface of Si₃N₄ grew from 3 to 7 nm. Agglomerated TiO₂ particles (see arrows) were observed in the samples obtained after 130 min, but tended to disappear after 190 min. TiO₂ coated Si₃N₄ particles were similarly prepared from the suspension containing 0.084 ml TiCl₄ and 1.6 g l⁻¹ Si₃N₄ corresponding to 10 vol% TiN with a hydrolysis time of 190 min (Fig. 4). It is obvious that the amount of TiO₂ covering the Si₃N₄ particles is less than for the corresponding 25 vol% TiN sample (Fig. 2). This

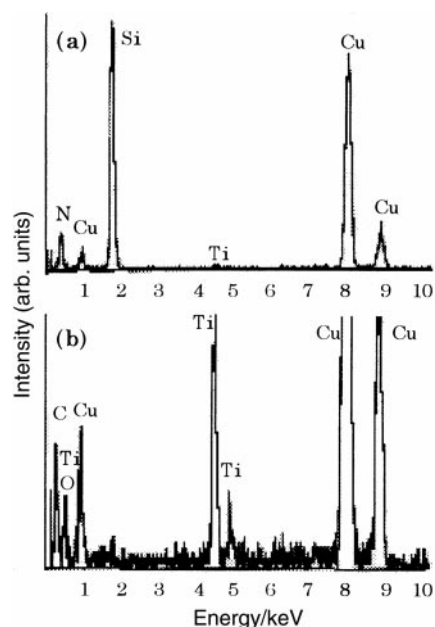


Fig. 3 EDX spectra for the particles shown in Fig. 2(c): (a) larger particle, (b) fine particle. Cu peaks are derived from the mesh and C from PVD carbon which provided the sample conductivity.

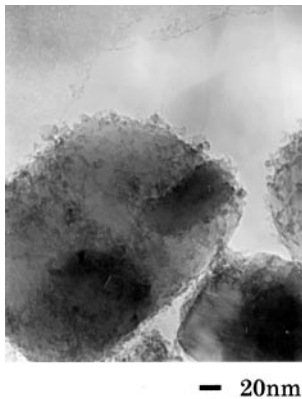


Fig. 4 TEM image of TiO₂ coated α -Si₃N₄ particles from 10 vol% TiN.

indicates that the coating of Si₃N₄ surfaces with the desired amount of TiO₂ is achieved simply by controlling the amount of TiCl₄.

Fig. 5 shows the change of the zeta potential with pH in a solution containing Si₃N₄ and TiO₂ particles. The signs of the zeta potential of Si₃N₄ and TiO₂ are opposite at pH values between 3.7 and 4.3. It is anticipated that the deposition of TiO₂ on the surface of the Si₃N₄ particles occurs in this pH region by attractive forces between the two types of particles with opposite charges. For comparison, coating of TiO₂ on Si₃N₄ was attempted by direct precipitation from TiCl₄ in aqueous NH₃ solution at pH 13.7 without urea, but scarcely any reaction was observed. It is concluded that the coating of TiO₂ on the surfaces of Si₃N₄ particles from TiCl₄ solution occurs at a pH between 3.7 and 4.3, which is achieved by increasing the pH as a result of the decomposition of the urea.

Nitridation

Preliminary experiments showed that TiO₂ particles produced by the thermal hydrolysis of TiCl₄ were not completely nitrided by NH₃ gas at 900 °C, but were fully converted to TiN at 1000 °C. When the TiO₂ coating on the surface of Si₃N₄ particles was nitrided at 1000 °C for 180 min, complete conversion to TiN was observed, as shown by XRD (Fig. 6). Compared with the lattice constant value ($a_0 = 0.424$ nm) of pure TiN, the a_0 value of TiN obtained after a hydrolysis time of 190 min ($a_0 = 0.422$ nm) was smaller, indicating the dissolution of a small amount of oxygen in the TiN. As shown by the TEM images (Fig. 7), the Si₃N₄ particles are coated with TiN particles of a uniform size (20 nm), independent of the hydrolysis time (130–190 min) or the TiN content (10 or 25 vol%). The electrical resistivity of the compact powder containing 25 vol% TiN was measured to be 0.1 Ω cm. Although the electrical resistivity was not as low as for the bulk TiN sample, the result suggested that electrical conductive

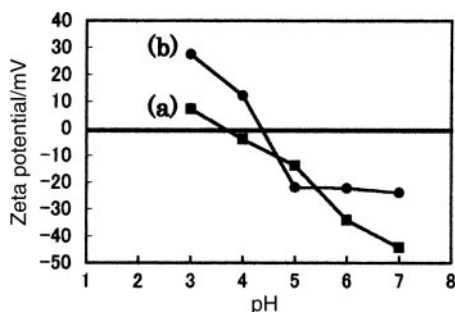


Fig. 5 Zeta potentials as a function of the pH: (a) α -Si₃N₄, (b) TiO₂.

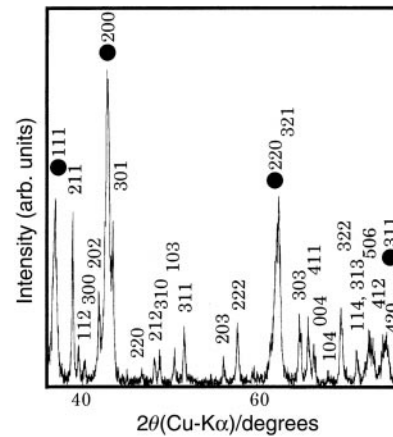


Fig. 6 XRD pattern of TiN coated α -Si₃N₄ particles: (●) TiN, (○) α -Si₃N₄.

paths provided by TiN coating should be formed through the powder compact.

Conclusion

Fine TiO₂ (anatase) particles were deposited on the surface of Si₃N₄ particles by thermal hydrolysis of TiCl₄ by the decomposition of urea in the suspension. The result was confirmed by TEM, EDX and XRD. The TiO₂ particles grew from 3 to 7 nm on increasing the hydrolysis time from 130 to 190 min. Zeta potential measurements suggested that TiO₂ coating on the surface of Si₃N₄ occurs at a pH between 3.7 and 4.3. When the TiO₂ coated Si₃N₄ composite particles were nitrided in NH₃ gas at 1000 °C, the coating was converted to TiN particles of uniform 20 nm size.

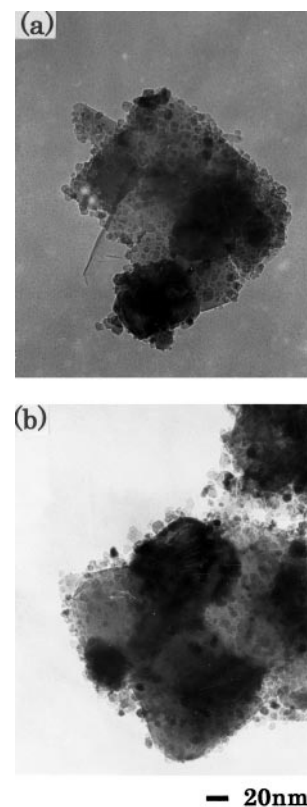


Fig. 7 TEM images of TiN coated α -Si₃N₄ particles: TiN content (vol%): (a) 10, (b) 25.

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